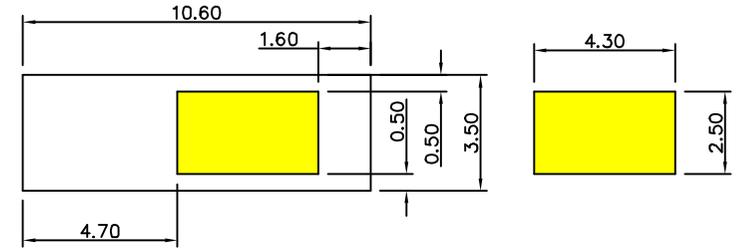
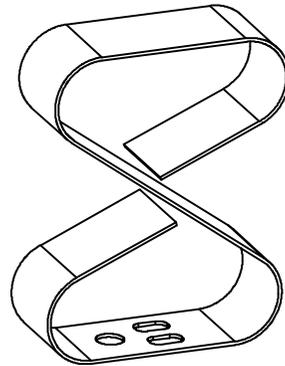
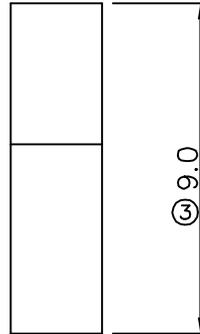
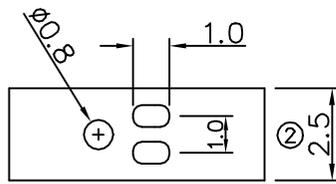
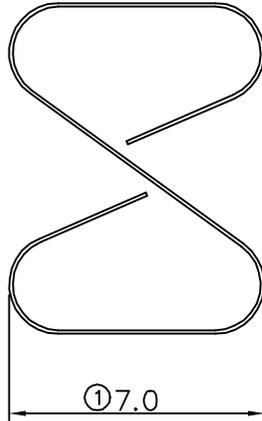
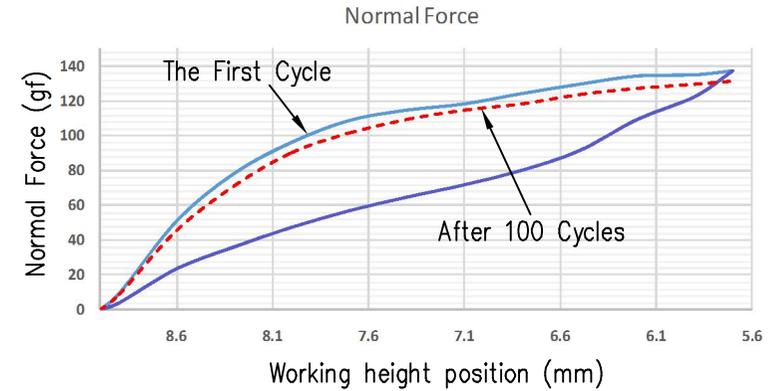


00 06/08-'06



RECOMMENDED SOLDERING PCB LAYOUT  
TOLERANCE(.XX±0.05)



Note:

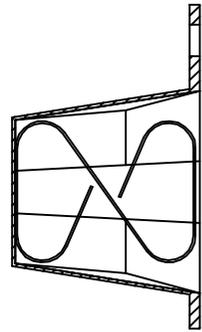
1. Material: Beryllium copper Thickness 0.10mm
2. Electroplate:  
Gold Flash on contact area  
Gold Flash on solder area  
Nickel underplating over all
3. Electrical Characteristics:  
3-1 Current Voltage: 12V  
3-2 Current Rate: 3A  
3-3 Contact Resistance: Normal Compression < 30mΩ
4. Working Height of Application: 5.7~8.3 mm
5. Spring Force Tolerance is ±30gf
6. Operating Temperature: -20℃~+85℃

00	06/08-'06	Design creation			
REV	Date	Description			
DRAFT	Dick Chang	DATE	06/08-'06	RoHS Compatible	
CHECKER	Jacky Lin	DATE	06/08-'06		
APPROVAL	Gary Chen	DATE	06/08-'06	SHEET	1-2
		SCALE	Not to scale	UNIT	mm

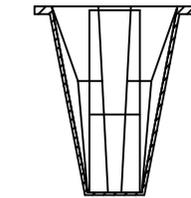
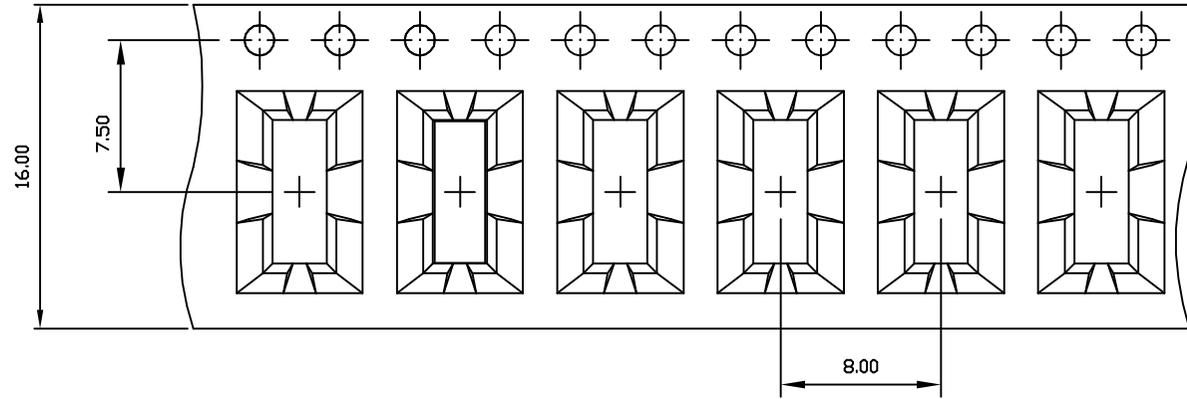
TOLERANCE/CLASS			
RANGE(mm)	1	2	3
≤30	±0.10	0.15	0.20
30< ≤120	±0.15	0.20	0.30
120< ≤300	±0.20	0.30	0.50
300<	±0.30	0.50	0.80
ANGLES	±2.5°		

**EMI STOP CORP.**  
EMI STOP  
EMISTOP S8-90RCG  
CUS P/N

00 11/05-19'

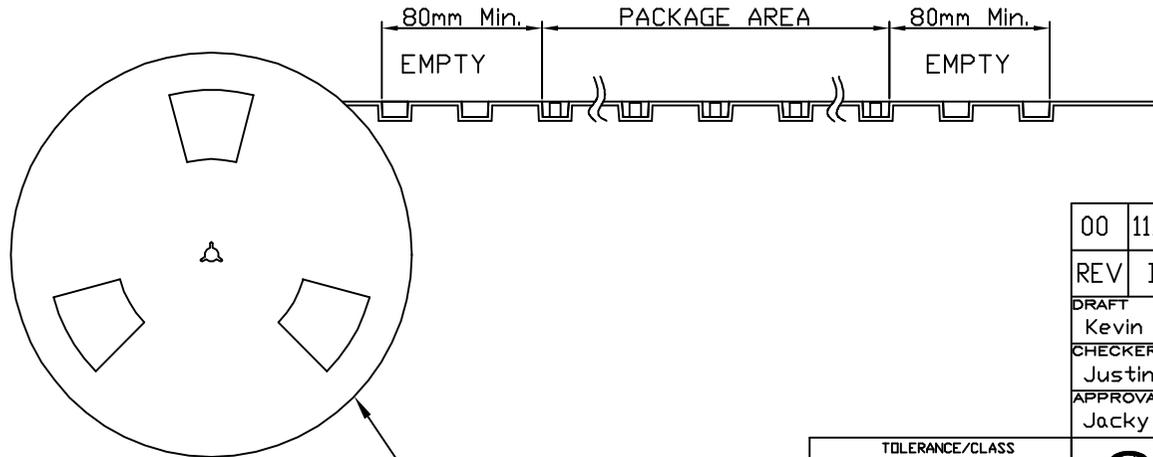


Side View



Front View

FEEDING DIRECTION



REEL(13")

Package Information:  
 1.Quantity Per Reel: 1000PCS  
 2.REEL: 13"X 16 mm

TOLERANCE/CLASS			
RANGE(mm)	1	2	3
≤30	±0.10	0.15	0.20
30<- ≤120	±0.15	0.20	0.30
120<- ≤300	±0.20	0.30	0.50
300<	±0.30	0.50	0.80
ANGLES	±2.5°		

00	11/05-19'	Design creation						
REV	Date	Description						
DRAFT	Kevin Chen	DATE	11/05-19'	<b>RoHS Compatible</b>				
CHECKER	Justin Wu	DATE	11/05-19'					
APPROVAL	Jacky Lin	DATE	11/05-19'					
		SHEET	2-2	SCALE	Not to scale	UNIT	mm	



**EMI STOP CORP.**

EMISTOP  
S8-90RCG

CUS P/N